

Dear Colleagues:

Engineering Mechanics Institute Conference(EMI2020) and Probabilistic Mechanics and Reliability Conference(PMC2020) will be held at Columbia University in New York City, May 26-29, 2020 (<https://www.emi-conference.org/>). As a part of this conference, we are organizing a mini-symposium “**Computational Methods and Applications for Solid and Structural Mechanics**”, to provide a forum for discussing novel computational methods and their applications that pertain to solids and structural mechanics problems. In particular, contributions on the following topics are of significant interest:

- § Novel computational methods for contact, fracture, interface modeling and other important engineering problems.
- § Application of deep learning in predicting the mechanical behavior of materials
- § Multiscale modeling and methods for heterogeneous materials including composites, concrete, wood, and others.
- § Novel discretization techniques for complex constitutive models and complex geometry
- § Multiscale modeling and methods for structural mechanics problems.
- § Computational methods for time dependent structural and material response (collapse, creep, fatigue, etc.).
- § Modeling of multiphysics phenomena (e.g., coupling of mechanics with electromagnetic, chemical, or transport effects).
- § Solution techniques, error estimation, algorithmic analysis and convergence studies in computational mechanics.

We cordially invite you to submit your abstract for this mini-symposium. Please note that the deadline for abstract submission is **Jan. 15th, 2020**. You can submit your abstract using the following link (our session is listed as symposium 251):

<https://www.emi-conference.org/program/call-abstracts>

We hope you can join us in the EMI conference and look forward to seeing you in New York.

Best wishes,

**Soheil Soghrati**, The Ohio State University

**Tim Truster**, University of Tennessee

**Ravi Duddu**, Vanderbilt University

**Ertugrul Taciroglu**, University of California – Los Angeles

**Guglielmo Scovazzi**, Duke University

**Xiang Zhang**, University of Wyoming